

HD74LVCR2245A

Octal Bidirectional Transceivers with 3-state Outputs

REJ03D0377-0400
 (Previous ADE-205-235B (Z))
 Rev.4.00
 Aug. 20, 2004

Description

The HD74LVCR2245A has eight buffers with three state outputs in a 20 pin package. When (T/\bar{R}) is high, data flows from the A inputs to the B outputs, and when (T/\bar{R}) is low, data flows from the B inputs to the A outputs. A and B bus are separated by making enable input (\overline{OE}) high level.

All outputs, which are designed to sink up to 12mA, include equivalent 26 Ω resistors to reduce overshoot and undershoot.

Low voltage and high-speed operation is suitable at battery drive product (note type personal computer) and low power consumption extends the life of a battery for long time operation.

Features

- $V_{CC} = 1.65$ to 5.5 V
- All inputs $V_{IH}(\text{Max}) = 5.5$ V (@ $V_{CC} = 0$ to 5.5 V)
- All inputs / outputs $V_{I/O}(\text{Max}) = 5.5$ V (@ $V_{CC} = 0$ V or output off state)
- Typical V_{OL} ground bounce < 0.8 V (@ $V_{CC} = 3.3$ V, $T_a = 25^\circ\text{C}$)
- Typical V_{OH} undershoot > 2.0 V (@ $V_{CC} = 3.3$ V, $T_a = 25^\circ\text{C}$)
- High output current $\pm 12\text{mA}$ (@ $V_{CC} = 3.0$ to 5.5 V)
- All outputs have equivalent 26 Ω series resistors, so no external resistors are required
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LVCR2245AFPEL	SOP-20 pin (JEITA)	FP-20DAV	FP	EL (2,000 pcs/reel)
HD74LVCR2245ATELL	TSSOP-20 pin	TTP-20DAV	T	ELL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

Function Table

Inputs

\overline{OE}	T/\bar{R}	Operation
L	L	B data to A bus
L	H	A data to B bus
H	X	Z

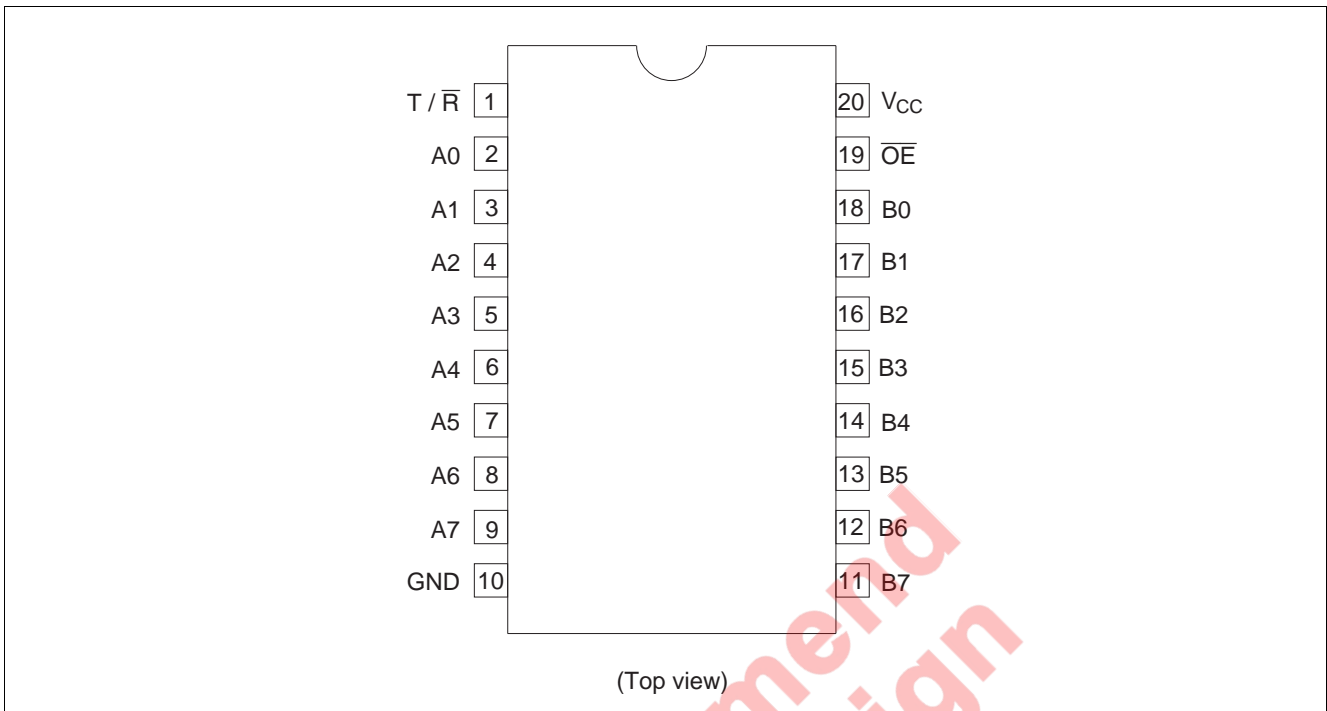
H: High level

L: Low level

X: Immaterial

Z: High impedance

Pin Arrangement



Absolute Maximum Ratings

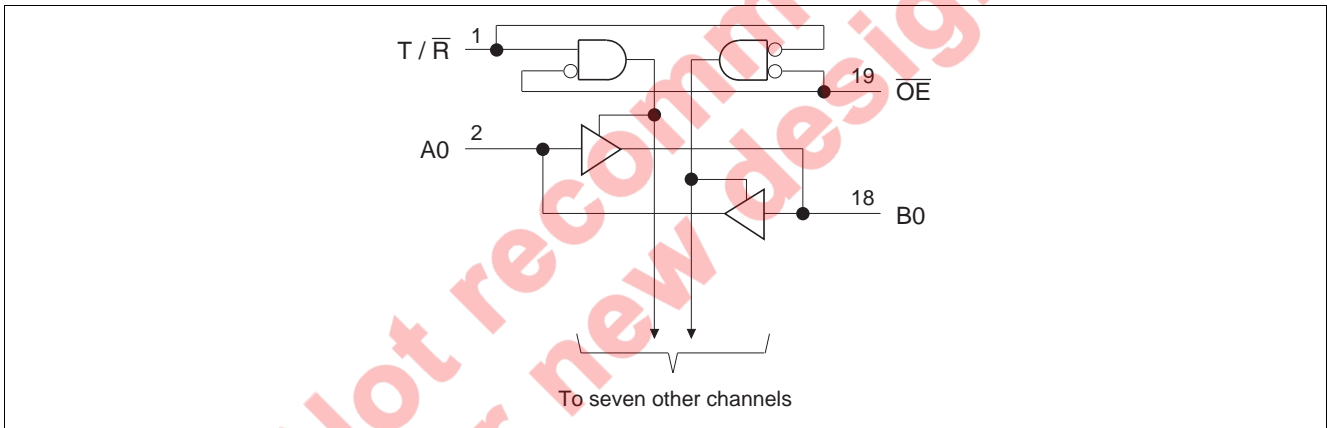
Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	-0.5 to 7.0	V	
Input voltage	V_I	-0.5 to 7.0	V	
Output voltage	V_O	-0.5 to 7.0	V	Output "Z" or V_{CC} : OFF
		-0.5 to $V_{CC}+0.5$		Output "H" or "L"
Input diode current	I_{IK}	-50	mA	$V_I < 0$
Output diode current	I_{OK}	-50	mA	$V_O < 0$
Output current	I_O	± 50	mA	
V_{CC} , GND current	I_{CC} or I_{GND}	± 100	mA	
Storage temperature	T_{stg}	-65 to 150	$^{\circ}C$	

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	1.65 to 5.5	V	At operation
		1.5 to 5.5		Data retention only
Input voltage	V_I	0 to 5.5	V	
Output voltage	V_O	0 to 5.5	V	Output "Z" or V_{CC} : OFF
		0 to V_{CC}		Output "H" or "L"
Output current	I_{OH}	-2	mA	$V_{CC} = 1.65\text{ V}$
		-4		$V_{CC} = 2.3\text{ V}$
		-8		$V_{CC} = 2.7\text{ V}$
		-12		$V_{CC} = 3.0\text{ to }5.5\text{ V}$
	I_{OL}	2	mA	$V_{CC} = 1.65\text{ V}$
		4		$V_{CC} = 2.3\text{ V}$
		8		$V_{CC} = 2.7\text{ V}$
		12		$V_{CC} = 3.0\text{ to }5.5\text{ V}$
Input rise / fall time	t_r, t_f	0 to 6	ns / V	
Operating temperature	T_a	-40 to +85	°C	

Logic Diagram



Electrical Characteristics

(Ta = -40 to 85°C)

Item	Symbol	V _{CC} (V)	Min	Typ	Max	Unit	Test Conditions
Input voltage	V _{IH}	1.65 to 1.95	V _{CC} ×0.65	—	—	V	
		2.3 to 2.7	1.7	—	—		
		2.7 to 3.6	2.0	—	—		
		4.5 to 5.5	V _{CC} ×0.7	—	—		
	V _{IL}	1.65 to 1.95	—	—	V _{CC} ×0.35	V	
		2.3 to 2.7	—	—	0.7		
		2.7 to 3.6	—	—	0.8		
		4.5 to 5.5	—	—	V _{CC} ×0.3		
Output voltage	V _{OH}	1.65 to 5.5	V _{CC} -0.2	—	—	V	I _{OH} = -100 μA
		1.65	1.2	—	—		I _{OH} = -2 mA
		2.3	1.7	—	—		I _{OH} = -4 mA
		2.7	2.2	—	—		
		3.0	2.4	—	—		I _{OH} = -6 mA
		2.7	2.0	—	—		I _{OH} = -8 mA
		3.0	2.0	—	—		I _{OH} = -12 mA
		4.5	3.6	—	—		
	V _{OL}	1.65 to 5.5	—	—	0.2	V	I _{OL} = 100 μA
		1.65	—	—	0.45		I _{OL} = 2 mA
		2.3	—	—	0.7		I _{OL} = 4 mA
		2.7	—	—	0.4		
		3.0	—	—	0.55		I _{OL} = 6 mA
		2.7	—	—	0.6		I _{OL} = 8 mA
3.0	—	—	0.8	I _{OL} = 12 mA			
4.5	—	—	0.8				
Input current	I _{IN}	0 to 5.5	—	—	±5	μA	V _{IN} = 0 to 5.5 V
Off state output current	I _{OZ}	1.65 to 5.5	—	—	±5	μA	V _{OUT} = 0 to 5.5 V
Output leak current	I _{OFF}	0	—	—	±5	μA	V _{IN} or V _O = 5.5 V
Quiescent supply current	I _{CC}	1.65 to 3.6	—	—	10	μA	V _{IN} = 3.6 to 5.5 V ^{*1} , I _O = 0
		1.65 to 5.5	—	—	10		V _{IN} = V _{CC} or GND
	ΔI _{CC}	2.7 to 3.6	—	—	500	μA	V _{IN} = one input at (V _{CC} -0.6)V, other inputs at V _{CC} or GND
Input capacitance	C _{IN}	3.3	—	3.4	—	pF	V _{IN} = V _{CC} or GND
Input output capacitance	C _{I/O}	3.3	—	9.5	—	pF	V _{OUT} = V _{CC} or GND

Note: 1. This applies in the disabled state only.

Switching Characteristics

(Ta = -40 to 85°C)

Item	Symbol	V _{CC} (V)	Min	Typ	Max	Unit	FROM (Input)	TO (Output)
Propagation delay time	t _{PLH}	1.8±0.15	—	—	15.0	ns	A or B	B or A
	t _{PHL}	2.5±0.2	—	—	9.0			
		2.7	—	—	7.3			
		3.3±0.3	1.5	—	6.3			
		5.0±0.5	—	—	4.8			
Output enable time	t _{ZH}	1.8±0.15	—	—	18.0	ns	OE	A or B
	t _{ZL}	2.5±0.2	—	—	11.0			
		2.7	—	—	9.5			
		3.3±0.3	1.5	—	8.2			
		5.0±0.5	—	—	6.8			
Output disable time	t _{HZ}	1.8±0.15	—	—	16.0	ns	OE	A or B
	t _{LZ}	2.5±0.2	—	—	10.0			
		2.7	—	—	8.5			
		3.3±0.3	1.7	—	7.8			
		5.0±0.5	—	—	6.6			
Between output pin skew ^{*1}	t _{OSLH}	1.8±0.15	—	—	2.0	ns		
	t _{OSSL}	2.5±0.2	—	—	2.0			
		2.7	—	—	1.5			
		3.3±0.3	—	—	1.0			
		5.0±0.5	—	—	1.0			

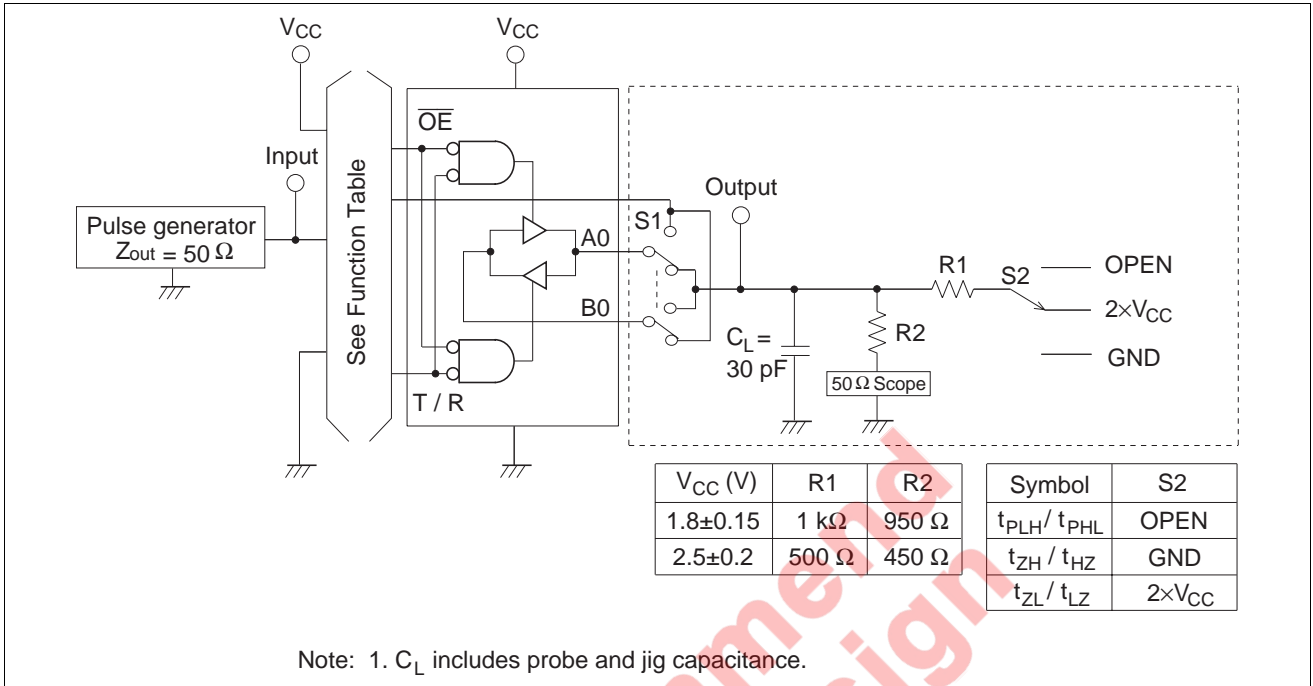
Note: 1. This parameter is characterized but not tested.

$$t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSSL} = |t_{PHLm} - t_{PHLn}|$$

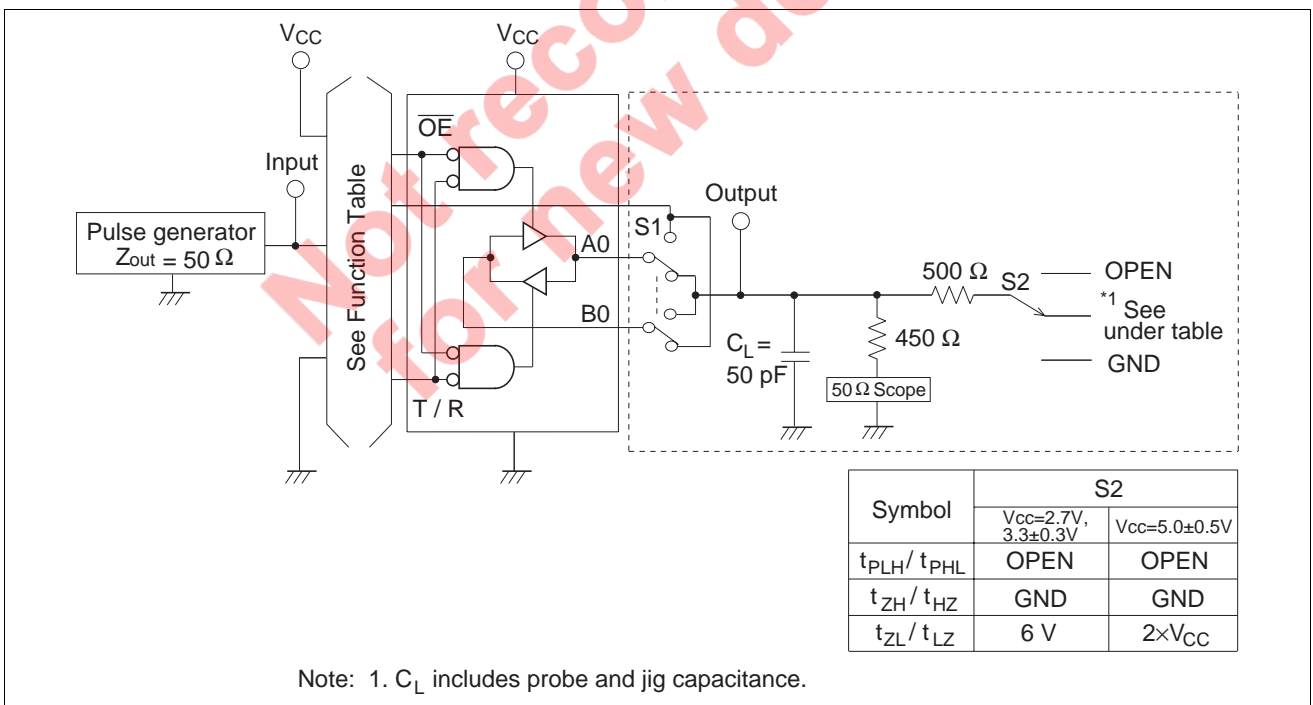
Not recommended for new design

Test Circuit

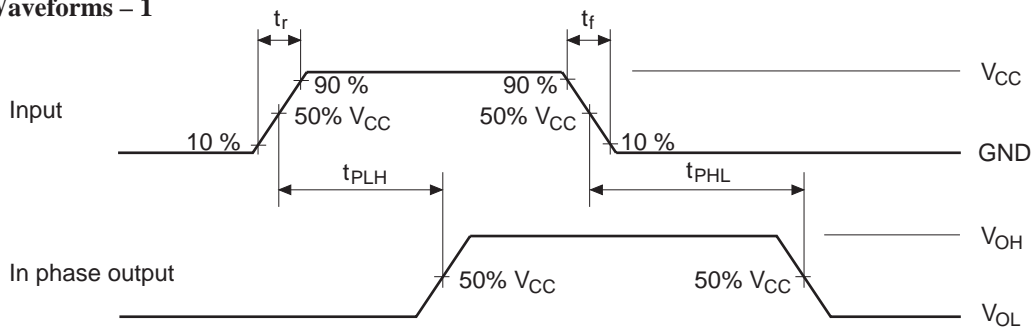
($V_{CC} = 1.8 \pm 0.15 \text{ V}$, $V_{CC} = 2.5 \pm 0.2 \text{ V}$)



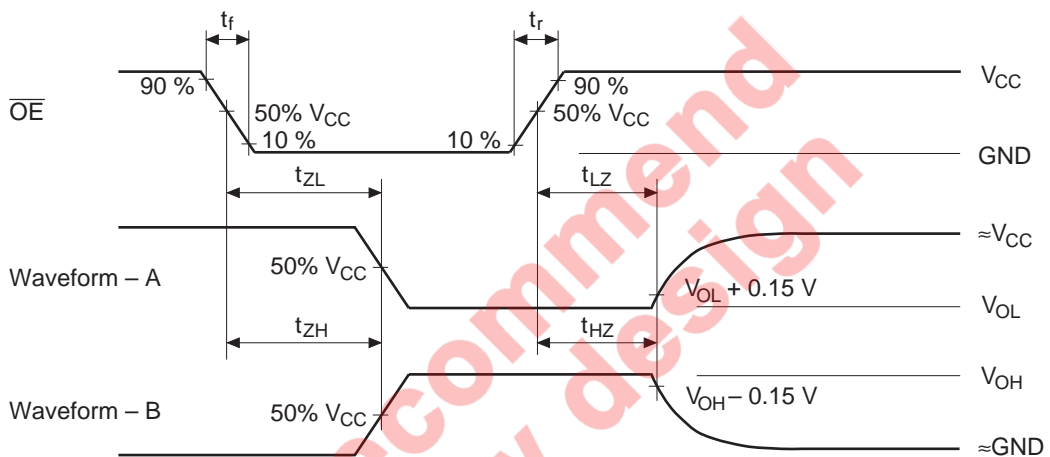
($V_{CC} = 2.7 \text{ V}$, $V_{CC} = 3.3 \pm 0.3 \text{ V}$, $V_{CC} = 5.0 \pm 0.5 \text{ V}$)



• Waveforms – 1

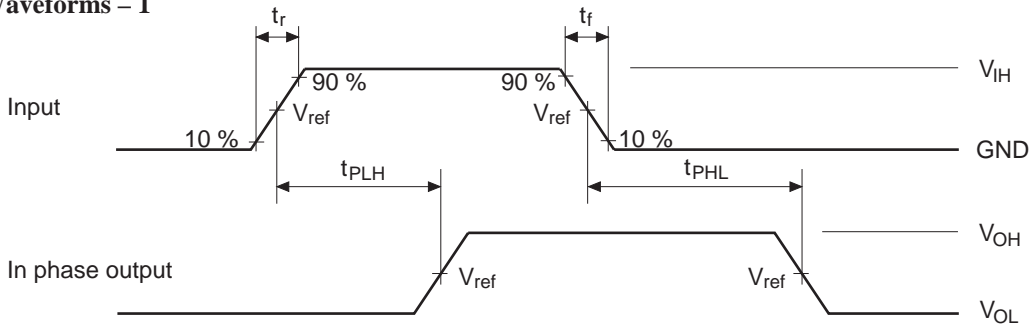


• Waveforms – 2

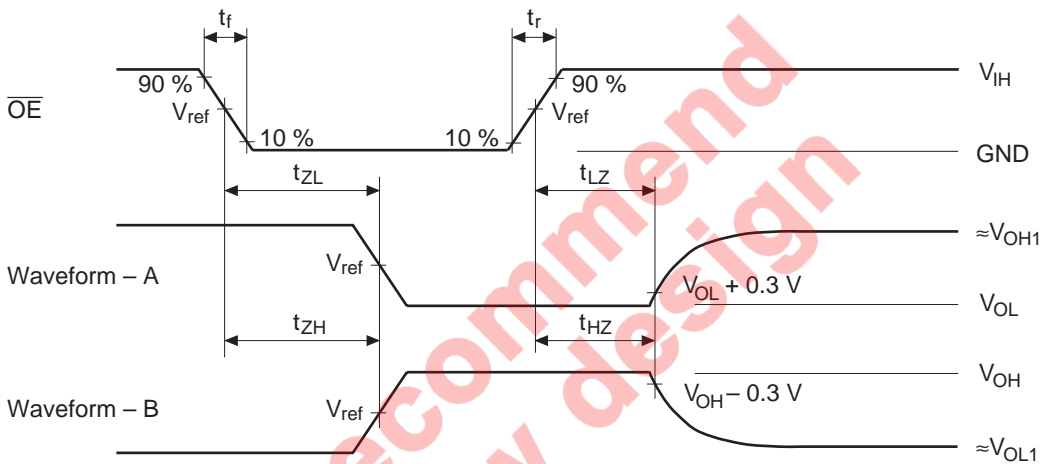


- Notes: 1. Input waveform : PRR = 10 MHz, duty cycle 50%, $t_r = 2.0 \text{ ns}$, $t_f = 2.0 \text{ ns}$
 2. Waveform – A shows input conditions such that the output is "L" level when enabled by the output control.
 3. Waveform – B shows input conditions such that the output is "H" level when enabled by the output control.

• Waveforms – 1



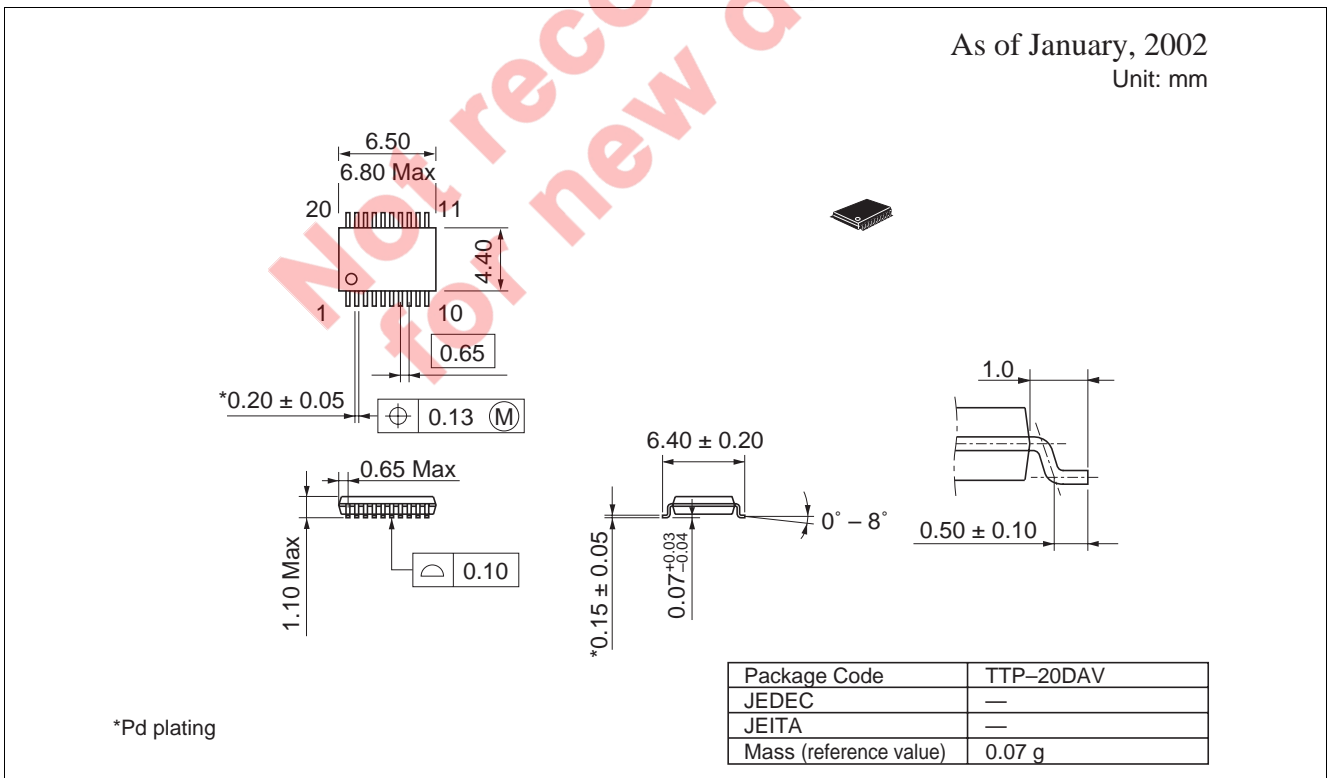
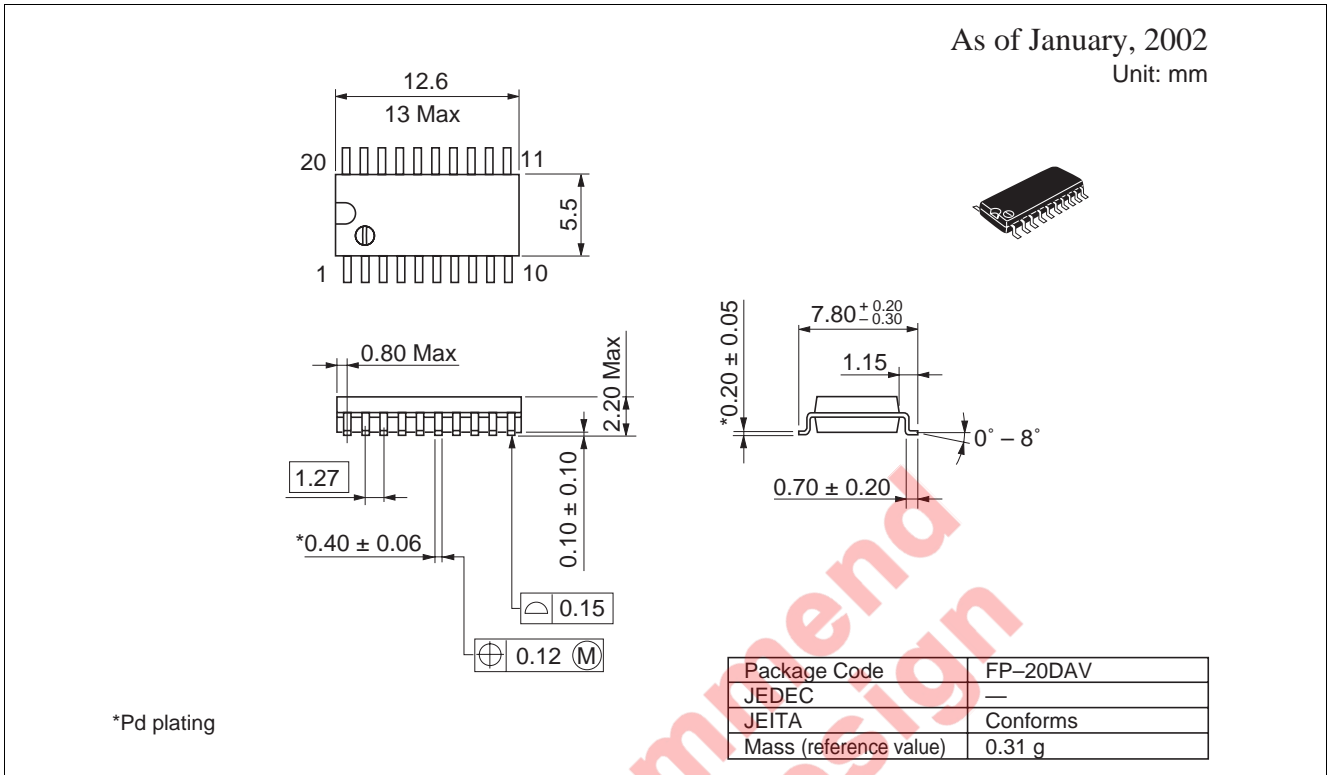
• Waveforms – 2



TEST	$V_{CC}=2.7\text{ V}$ $3.3 \pm 0.3\text{ V}$	$V_{CC}=5.0 \pm 0.5\text{ V}$
V_{IH}	2.7 V	V_{CC}
V_{ref}	1.5 V	$50\%V_{CC}$
V_{OH1}	3 V	V_{CC}
V_{OL1}	GND	GND

- Notes: 1. Input waveform : PRR = 10 MHz, duty cycle 50%, $t_r = 2.5\text{ ns}$, $t_f = 2.5\text{ ns}$
 2. Waveform – A shows input conditions such that the output is "L" level when enabled by the output control.
 3. Waveform – B shows input conditions such that the output is "H" level when enabled by the output control.

Package Dimensions



Keep safety first in your circuit designs!

1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.
 2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
 3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.
The information described here may contain technical inaccuracies or typographical errors.
Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (<http://www.renesas.com>).
 4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
 5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
 6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.
 7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
 8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.
-



RENESAS SALES OFFICES

<http://www.renesas.com>

Renesas Technology America, Inc.

450 Holger Way, San Jose, CA 95134-1368, U.S.A
Tel: <1> (408) 382-7500 Fax: <1> (408) 382-7501

Renesas Technology Europe Limited.

Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, United Kingdom
Tel: <44> (1628) 585 100, Fax: <44> (1628) 585 900

Renesas Technology Europe GmbH

Dornacher Str. 3, D-85622 Feldkirchen, Germany
Tel: <49> (89) 380 70 0, Fax: <49> (89) 929 30 11

Renesas Technology Hong Kong Ltd.

7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Hong Kong
Tel: <852> 2265-6688, Fax: <852> 2375-6836

Renesas Technology Taiwan Co., Ltd.

FL 10, #99, Fu-Hsing N. Rd., Taipei, Taiwan
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd.

26/F., Ruijin Building, No.205 Maoming Road (S), Shanghai 200020, China
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd.

1, Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001